

40W PEAK POWER DUAL SURFACE MOUNT TVS

Features

- Dual TVS in Common Cathode Configuration for ESD Protection
- 40 Watt Peak Power Dissipation @1.0ms (Unidirectional)
- 225mW Power Dissipation
- Ideally Suited for Automated Insertion
- Low Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3 & 4)
- The MMBZ27VCLQ-7-F is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

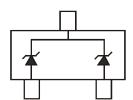
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic.
 UL Flammability Rating Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 (3)
 Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42
 Leadframe)
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)

SOT23



Top View



Device Schematic

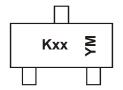
Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging	
MMBZ27VCL-7-F	Standard	SOT23	3000/Tape & Reel	
MMBZ27VCLQ-7-F	Automotive	SOT23	3000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



xx = Product Type Marking Code YM = Date Code Marking for Shanghai Assembly / Test site Y = Year (ex: I = 2021)

M = Month (ex: 9 = September)

Kxx ≥

xx = Product Type Marking Code $\overline{Y}M$ = Date Code Marking for Chengdu Assembly / Test site \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2006		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	Т		I	J	K	L	M	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	2	2	4	E	6	7	0	0	0	NI	7



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Peak Power Dissipation (Note 5)	P _{PK}	40	W	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_{D}	225	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{OJA}	556	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)

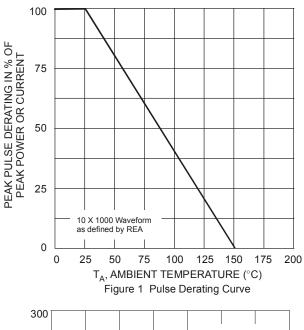
$V_F = 1.1V \text{ max } @ I_F = 200\text{mA}$

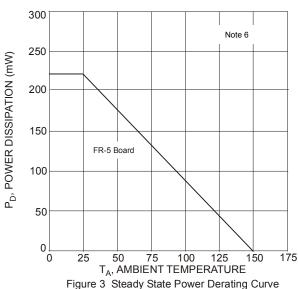
Typo	T Manisina		Max Reverse	Breakdown Voltage				Max. Clamping Voltage V _C @ I _{PP} (Note 5)		Typical Temperature
Type Number	Marking Code	V _{RWM}	Leakage I _R @ V _{RWM} (Note 7)	V _{BR} (Note 7) (V)		@ I _⊤	Vc	I _{PP}	Coefficient	
		Volts	nA	Min	Nom	Max	mA	٧	Α	T _c (%/°C)
MMBZ27VCL	KVP	22	50	25.65	27	28.35	1.0	38	1.0	+0.090

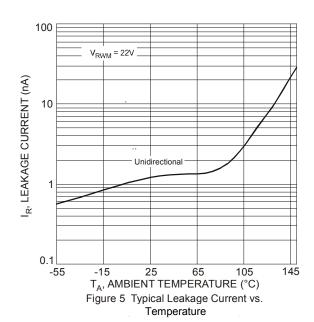
Notes:

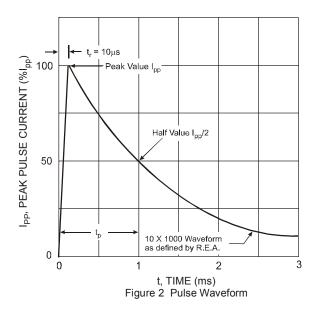
- 5. Non-repetitive current pulse per Figure 2 and derate above T_A = +25°C per Figure 1. 6. Device mounted on FR-5 PCB 1.0 × 0.75 × 0.062 inch pad layout. 200mW per element must not be exceeded.
- 7. Short duration pulse test used to minimize self-heating effect.

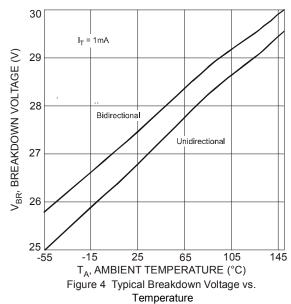












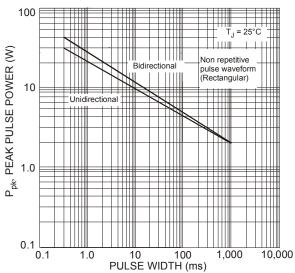
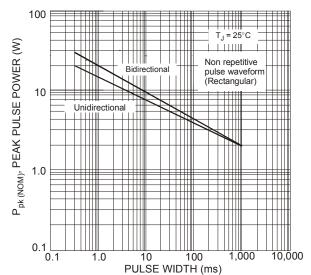


Figure 6 Pulse Rating Curve, $P_{pk}(W)$ vs. Pulse Width (ms) Power is defined as $P_{pk} = V_C \times I_{pp}$



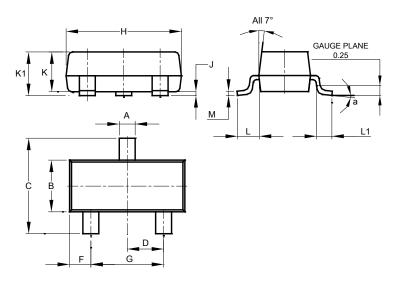




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

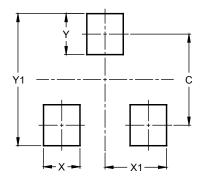


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
C	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°	_				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	29



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